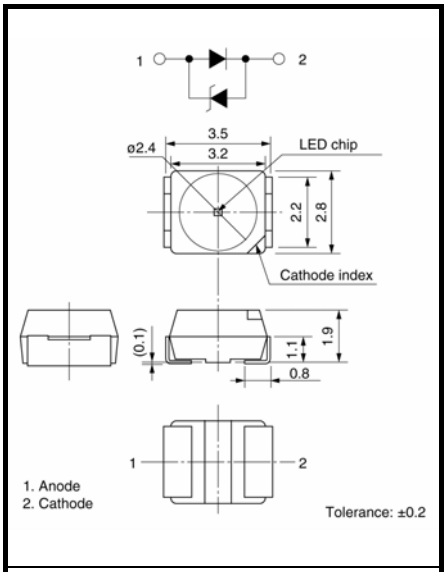
TOSHIBA LED Lamps

TLWH1100(T11)

Unit: mm

Panel Circuit Indicator

- Surface-mount devices
- 3.2 (L) × 2.8 (W) × 1.9 (H) mm
- UV LED chip + phosphor
- Luminous intensity : Iv = 450 mcd (typ.) @20mA
- Color: White
- Chromaticity (typ.) : Cx=0.33,Cy=0.32
- Topr / Tstg = -40 to 100°C
- Reflow soldering is possible
- Applications: automotive use,
  backlighting etc.
- Standard embossed tape packing: T11 (2000/reel)
  8-mm tape reel



JEDEC	—
JEITA	—
TOSHIBA	4-3R1

Weight: 0.035 g (typ.)

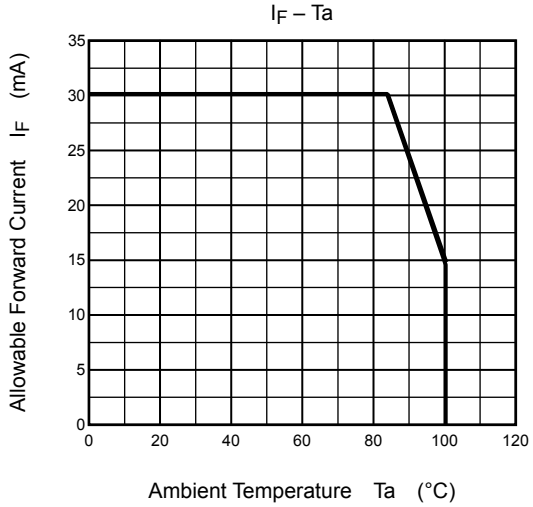
Color and Material

Product Name	Color	Material
TLWH1100	White	GaN

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Forward Current	(Note 1)	I_F	30	mA
Power Dissipation		P_D	126	mW
Operating Temperature		T_{opr}	−40~100	°C
Storage Temperature		T_{stg}	−40~100	°C

Note 1: Forward current derating



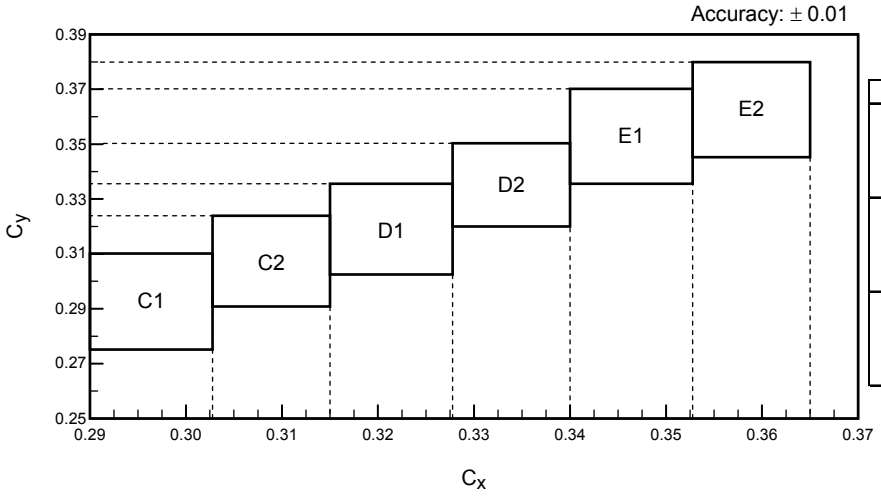
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test condition	Min.	Typ.	Max.	Unit
Forward Current	V_F	I_F = 20 mA	—	3.5	4.2	V
Reverse Voltage	V_R	I_R = 10 mA	—	0.75	—	V

Optical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test condition	Min.	Typ.	Max.	Unit
Chromaticity		C_x	I_F = 20 mA		(Note 2)		—
		C_y	I_F = 20 mA		(Note 2)		—
Luminous Intensity	(Note 3)	I_V	I_F = 20 mA	250	450	1250	mcd

Note 2: The product is tested at the following chromaticity coordinate groups.



	Cx	Cy		Cx	Cy
C1	0.303	0.275	C2	0.303	0.290
	0.303	0.310		0.303	0.325
	0.290	0.310		0.315	0.325
	0.290	0.275		0.315	0.290
D1	0.315	0.300	D2	0.328	0.315
	0.315	0.335		0.328	0.350
	0.328	0.335		0.340	0.350
	0.328	0.300		0.340	0.315
E1	0.340	0.335	E2	0.353	0.345
	0.340	0.370		0.353	0.380
	0.353	0.370		0.365	0.380
	0.353	0.335		0.365	0.345

Note 3: Iv rank classification

Test conditions: IF=20mA, Ta=25°C

Product name		Luminous intensity I_V			
		min	typ	max	I_F
TLWH1100(T11)		250	450	1250	20
	TA	250	—	500	
	UA	400	—	800	
	VA	630	—	1250	
Unit		mcd			mA

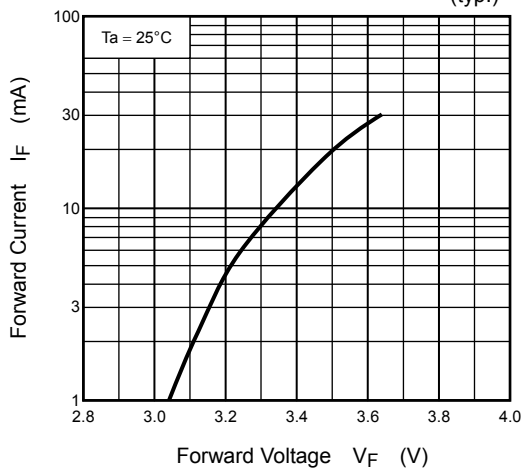
The specification on the above table is used for Iv classification of LEDs in Toshiba facility.
Each reel includes the same rank LEDs. Let the delivery ratio of each rank be unquestioned.

Note 4: Ultraviolet light luminescence
This white LED lamp also emits some UV light. (Around 360~400nm)
When this LED lamp is used for general indicator, it is no problem. However the LED is not recommended for the following applications.
(1) Prohibition
- Human eye is damaged by the condensed light. (Ex. microscope, outer lens, etc)
(2) Notice
- LED is located at near a skin (the distance is less than 20mm), and exposure time is more than 60 min.
- Photosensitive material is used with this LED in a set. It might be damaged by the light.

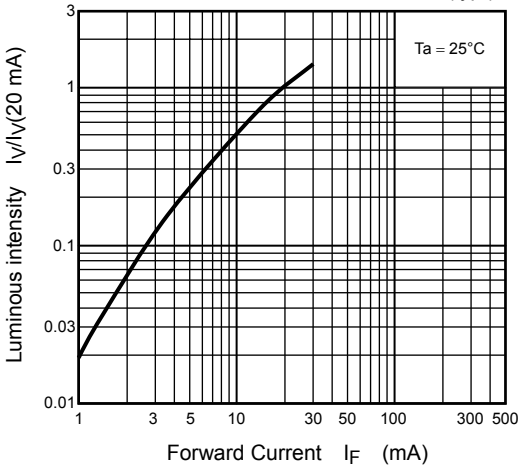
Note 5: Do not break, cut or pulverize the product.

TLWH1100

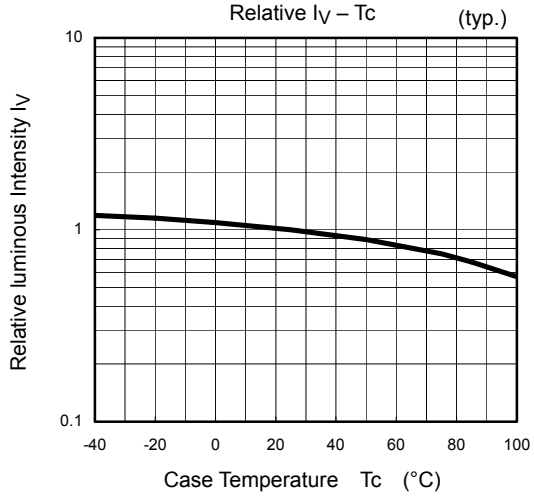
$I_F - V_F$ (typ.)



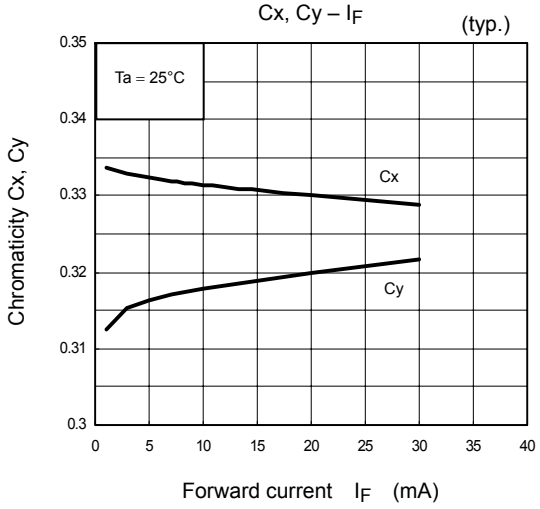
$I_V/I_V(20\ mA) - I_F$ (typ.)



Relative I_V – Tc (typ.)

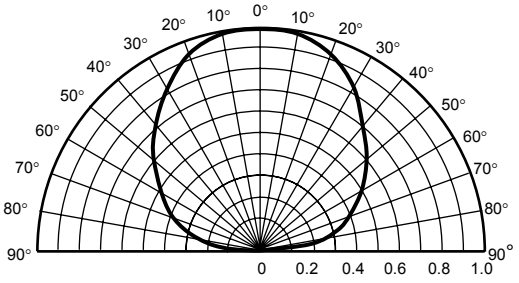


Cx, Cy – I_F (typ.)

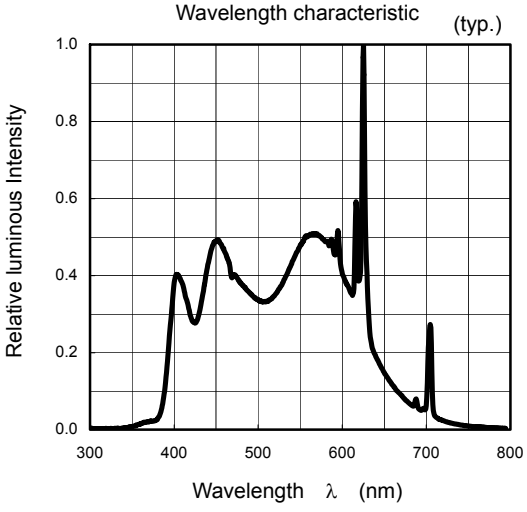


Radiation pattern

Ta = 25°C
(typ.)



Wavelength characteristic (typ.)



Packaging

These LED devices are packed in an aluminum envelope with a silica gel and a moisture indicator to avoid moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

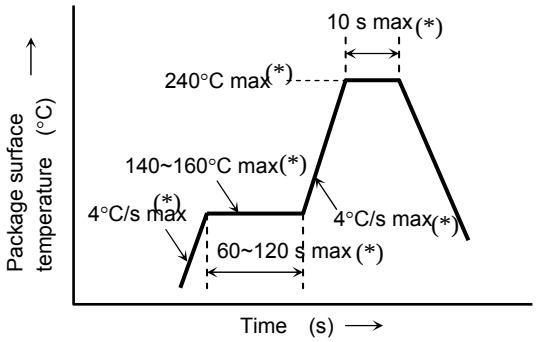
1. This moisture proof bag may be stored unopened within 12 months at the following conditions.
   Temperature: 5°C~30°C
   Humidity: 90% (max)
2. After opening the moisture proof bag, the devices should be assembled within 168 hours in an environment of 5°C to 30°C/60% RH or below.
3. If upon opening, the moisture indicator card shows humidity 30% or above (Color of indication changes to pink) or the expiration date has passed, the devices should be baked in taping with reel.
   After baking, use the baked devices within 72 hours, but perform baking only once.
   Baking conditions: 60±5°C, for 12 to 24 hours.
   Expiration date: 12 months from sealing date, which is imprinted on the same side as this label affixed.
4. Repeated baking can cause the peeling strength of the taping to change, then leads to trouble in mounting. Furthermore, prevent the devices from being destructed against static electricity for baking of it.
5. If the packing material of laminate would be broken, the hermeticity would deteriorate. Therefore, do not throw or drop the packed devices.

Mounting Method

Soldering

- Reflow soldering

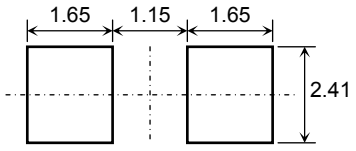
Temperature profile (example)



- The product is evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.
- Please perform the first reflow soldering with reference to the above temperature profile and within 168 h of opening the package.
- Second reflow soldering
  In case of second reflow soldering should be performed within 168 h of the first reflow under the above conditions.
  Storage conditions before the second reflow soldering: 30°C, 60% RH (max)
- Make any necessary soldering corrections manually.
  (only once at each soldering point)
  Soldering iron : 25 W
  Temperature : 300°C or less
  Time : within 3 s
- If the product needs to be performed by other soldering method (ex. wave soldering), please contact Toshiba sales representative.

Recommended soldering pattern

Unit: mm



Cleaning

When cleaning is required after soldering, Toshiba recommends the following cleaning solvents.
It is confirmed that these solvents have no effect on semiconductor devices in our dipping test (under the recommended conditions). In selecting the one for your actual usage, please perform sufficient review on washing condition, using condition and etc.

ASAHI CLEAN AK-225AES	: (made by ASAHI GLASS)
KAO CLEAN TROUGH 750H	: (made by KAO)
PINE ALPHA ST-100S	: (made by ARAKAWA CHEMICAL)
TOSHIBA TECHNOCARE (FRW-17, FRW-1, FRV-100)	: (made by GE TOSHIBA SILICONES)

Precautions when Mounting

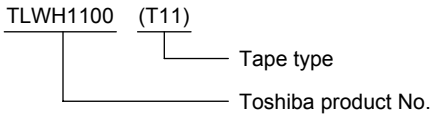
Do not apply force to the plastic part of the LED under high-temperature conditions.
To avoid damaging the LED plastic, do not apply friction using a hard material.
When installing the PCB in a product, ensure that the device does not come into contact with other cmponents.

Tape Specifications

1. Product number format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (this method, however does not apply to products whose electrical characteristics differ from standard Toshiba specifications)

(1) Tape Type: T11 (4-mm pitch)
(2) Example

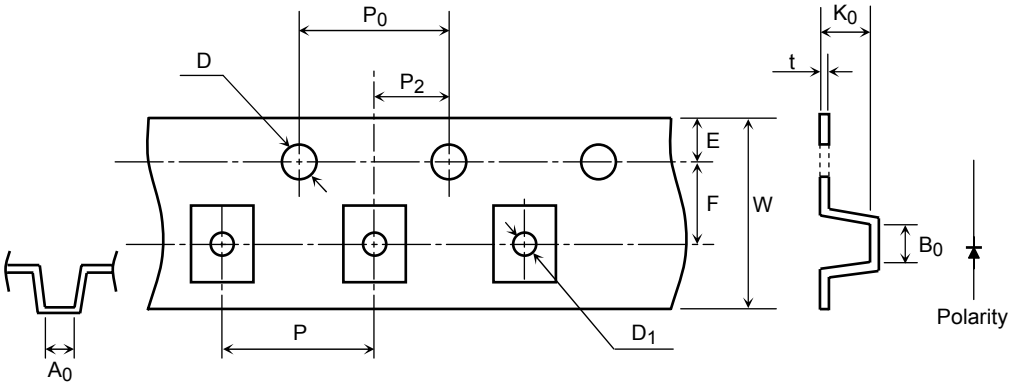


2. Tape dimensions

Unit: mm

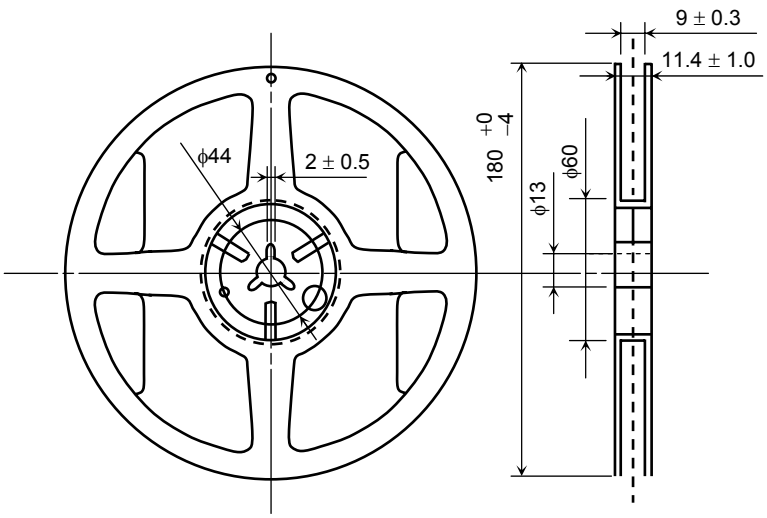
Symbol	Dimension	Tolerance
D	1.5	+0.1/–0
E	1.75	±0.1
P_0	4.0	±0.1
t	0.3	±0.05
F	3.5	±0.05
D_1	1.5	±0.1

Symbol	Dimension	Tolerance
P_2	2.0	±0.05
W	8.0	±0.3
P	4.0	±0.1
A_0	2.9	±0.1
B_0	3.7	±0.1
K_0	2.3	±0.1

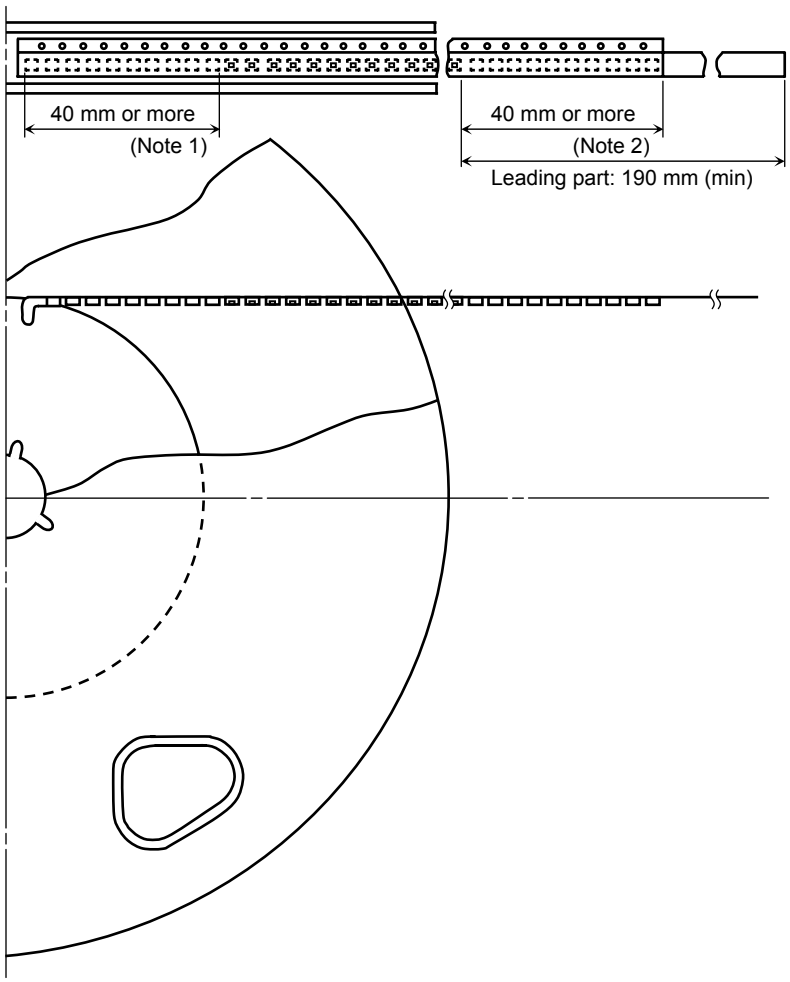


3. Reel dimensions

Unit: mm



4. Leader and trailer sections of tape



Note1: Empty trailer section

Note2: Empty leader section

5. Packing display

(1) Packing quantity

Reel	2,000 pcs
Carton	10,000 pcs

(2) Packing form: Each reel is sealed in an aluminum pack with silica gel.

6. Label format

(1) Example: TLWH1100 (T11)

P/N:

TYPE	**TLWH1100**		
ADDC	(T11)	Q'TY	2,000 pcs

Lot Number Key code for TSB 32C 2000
(RANK SYMBOL)

TOSHIBA

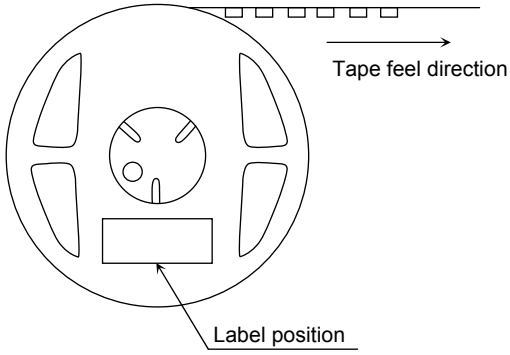
Use under 5-30degC/60%RH within 168h

[[G]]/RoHS COMPATIBLE
Y3804xxxxxxxxxxxxxxxx

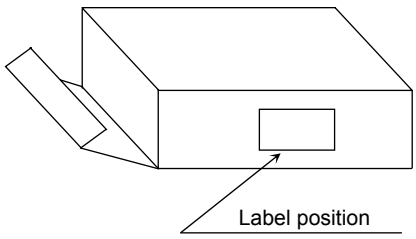
SEAL DATE:
DIFFUSED IN *****
ASSEMBLED IN *****

(2) Label location

- Reel



- Carton



- The aluminum package in which the reel is supplied also has the label attached to center of one side.

RESTRICTIONS ON PRODUCT USE

- The information contained herein is subject to change without notice.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the “Handling Guide for Semiconductor Devices,” or “TOSHIBA Semiconductor Reliability Handbook” etc.
- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury (“Unintended Usage”). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer’s own risk.
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